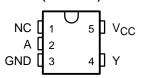
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- Operating Range 2-V to 5.5-V V_{CC}
- Latch-Up Performance Exceeds 250 mA Per JESD 17

description

The SN74AHC1G04 contains one inverter gate. The device performs the Boolean function $Y = \overline{A}$.

DBV OR DCK PACKAGES (TOP VIEW)



NC - No internal connection

ORDERING INFORMATION

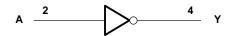
TA	PACKAGE [†]		ORDERABLE PART NUMBER	TOP-SIDE MARKING [‡]
-40°C to 85°C	SOT (SOT-23) – DBV	Tape and reel	SN74AHC1G04DBVR	A04_
-40 C 10 65 C	SOT (SC-70) - DCK	Tape and reel	SN74AHC1G04DCKR	AC_

[†] Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.

FUNCTION TABLE

INPUT A	OUTPUT Y
Н	L
L	Н

logic diagram (positive logic)





Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.



[‡]The actual top-side marking has one additional character that designates the assembly/test site.

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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range, V _{CC}	0.5 V to 7 V
Input voltage range, V _I (see Note 1)	0.5 V to 7 V
Output voltage range, VO (see Note 1)	
Input clamp current, I _{IK} (V _I < 0)	–20 mA
Output clamp current, I _{OK} (V _O < 0 or V _O > V _{CC})	±20 mA
Continuous output current, $I_O(V_O = 0 \text{ to } V_{CC})$	±25 mA
Continuous current through V _{CC} or GND	±50 mA
Package thermal impedance, θ_{JA} (see Note 2): DBV package	206°C/W
DCK package	252°C/W
Storage temperature range, T _{stg}	–65°C to 150°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

recommended operating conditions (see Note 3)

			MIN	MAX	UNIT
VCC	Supply voltage				V
		V _{CC} = 2 V	1.5		
V_{IH}	High-level input voltage	V _{CC} = 3 V	2.1		V
	V _{CC} = 5.5 V		3.85		
		V _{CC} = 2 V		0.5	
V _{IL}	Low-level input voltage V _{CC} = 3 V	V _{CC} = 3 V		0.9	V
	V _{CC} = 5.5 V			1.65	
VI	Input voltage		0	5.5	V
٧o	Output voltage		0	VCC	V
		V _{CC} = 2 V		-50	μΑ
loh	High-level output current	$V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$		-4	mA
		$V_{CC} = 5 V \pm 0.5 V$		-8 IIIA	
		V _{CC} = 2 V		50	μΑ
loL	Low-level output current $V_{CC} = 3.3 \text{ V} \pm 0$			4	A
		$V_{CC} = 5 V \pm 0.5 V$		8	mA
A+/A>r	Input transition rise or fall rate	$V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$		100	ns/V
Δt/Δv	Input transition rise or fall rate $V_{CC} = 5 \text{ V} \pm 0.5 \text{ V}$			20	115/V
TA	Operating free-air temperature		-40	85	°C

NOTE 3: All unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.



NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

^{2.} The package thermal impedance is calculated in accordance with JESD 51-7.

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS	Vcc	T _A = 25°C			MIN	MAX	UNIT	
PARAMETER			MIN	TYP	MAX	IVIIIN	WAX	UNIT	
		2 V	1.9	2		1.9			
	I _{OH} = -50 μA	3 V	2.9	3		2.9		V	
V _{OH}		4.5 V	4.4	4.5		4.4			
	$I_{OH} = -4 \text{ mA}$	3 V	2.58			2.48		}	
	$I_{OH} = -8 \text{ mA}$	4.5 V	3.94			3.8			
		2 V			0.1		0.1		
	I _{OL} = 50 μA	3 V			0.1		0.1		
VOL		4.5 V			0.1		0.1	V	
	I _{OL} = 4 mA	3 V			0.36		0.44		
	I _{OL} = 8 mA	4.5 V			0.36		0.44		
Ι _Ι	V _I = 5.5 V or GND	0 V to 5.5 V			±0.1		±1	μΑ	
Icc	$V_I = V_{CC}$ or GND, $I_O = 0$	5.5 V			1		10	μА	
Ci	$V_I = V_{CC}$ or GND	5 V		2	10		10	pF	

switching characteristics over recommended operating free-air temperature range, V_{CC} = 3.3 V \pm 0.3 V (unless otherwise noted) (see Figure 1)

PARAMETER	TER FROM TO LOAD CAPACITANCE	то	LOAD	T _A = 25°C			MIN	MAX	UNIT	
PARAMETER		MIN	TYP	MAX	UNIT					
^t PLH	۸	V	C _I = 15 pF		5	8.9	1	10.5	ne	
t _{PHL}	А	T I	CL = 15 pr		5	8.9	1	10.5	ns	
t _{PLH}	^	Y C _L = 50 pF	V	V 0: 50 = 5		7.5	11.4	1	13	no
t _{PHL}	1 A Y			7.5	11.4	1	13	ns		

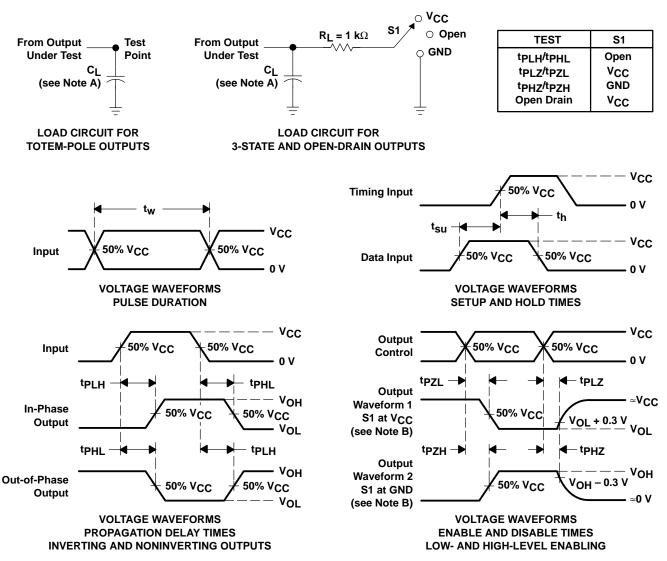
switching characteristics over recommended operating free-air temperature range, V_{CC} = 5 V \pm 0.5 V (unless otherwise noted) (see Figure 1)

PARAMETER	DADAMETED	METER FROM	то	TO LOAD	T _A = 25°C			MIN	MAX	UNIT
	(INPUT)	(OUTPUT)	CAPACITANCE	MIN	TYP	MAX] V 1	WAX	UNIT	
	^t PLH	Δ	V	C: _ 15 nE		3.8	5.5	1	6.5	20
	^t PHL	Α	Ť	C _L = 15 pF		3.8	5.5	1	6.5	ns
	tPLH A	Δ	Y	Y C _L = 50 pF		5.3	7.5	1	8.5	no
	^t PHL	А				5.3	7.5	1	8.5	ns

operating characteristics, V_{CC} = 5 V, T_A = 25°C

	PARAMETER		ONDITIONS	TYP	UNIT
C _{pd}	Power dissipation capacitance	No load,	f = 1 MHz	12	pF

PARAMETER MEASUREMENT INFORMATION



NOTES: A. C_L includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR \leq 1 MHz, $Z_O = 50 \Omega$, $t_f \leq 3$ ns. $t_f \leq 3$ ns.
- D. The outputs are measured one at a time with one input transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms



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